Conference Program at a glance Tuesday, February 14, 2023

The Westin Grand Hotel Munich
Event Room: Garmisch-Partenkirchen

18:30

NETWORKING DINNER



		20.01.2023
08:50		WELCOME & INTRODUCTION
09:00		WELCOME BY CHAIR: Sven Wiemer; Schill+Seilacher "Struktol" GmbH
09:00		Dr. Raphael Schaller; nolax AG Reliable Bond on Snow – Strong Interlaminar Adhesion in Skis
09:25		Tobias Hilse; University of Braunschweig / Institute of Joining and Welding Rapid Bonding of Wooden Modules for Ceiling Constructions
09:50		Dr. Belinda Berns; SME (subject matter expert) Optical Bonding Optical Bonding - A Whole New Industry – Challenges & Defects
10:15	- 10:45	REFRESHMENT BREAK
10:45		Tom Claessen; Avantium Renewable Polymers Bio-Refinery Derived Furanic Humins as Basis for Sustainable Thermosets and Adhesives
11:10		Tom Berckmans; Cardolite Specialty Chemicals Europe N.V. Cashew Nutshell Liquid-Based Epoxy Resins: Renewable Options for Epoxy Adhesives and Sealants
11:35		Nick Dewingaerden; Kaneka Belgium New Advancements in the Field of MS Polymer for High Strength / High Elongation Adhesives Applications
12:00	- 13:30	LUNCH
13:30		WELCOME BY CHAIR: Dr. Vera Haye; IVK - German Adhesives Association
13:30		Therese Hemery, PhD; Dymax Europe GmbH Dymax UV Technology for Precision Bonding and Optical Assembly in Automotive Applications
13:55		Peter Kraushofer & Jean-Francois Chartrel; Bostik Cyanoacrylate Adhesives - Opening New Perspectives in Assembly with Instant Adhesives Precision Dispensing
14:20		Tobias Bodenmüller; medmix Switzerland AG Sustainability in the Digital Development Process
14:45		Patrik Thoma; fitech AG Process Comparison of Viscous Adhesive and Sealant Production
15:15	- 15:45	REFRESHMENT BREAK
15:45		Hinrich Grefe; University of Braunschweig / Institute of Joining and Welding Structural Monitoring of Adhesively Strengthened Steel Structures with Distributed Fibreoptic Sensors
16:10	A H	Marco Rodriguez; as adhesive solutions e.K. The Digital Monitoring of Bonding Process Parameters
16:35		Ivo Neumann; Fraunhofer Institute for Manufacturing Technology and Advanced Materials IFAM Adhesive Bonding 4.0: Implementation of Unifies Communication Standard in the Adhesive Bonding Production

Conference Program at a glance Wednesday, February 15, 2023

The Westin Grand Hotel Munich Event Room: Garmisch-Partenkirchen



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WELCOME BY CHAIR: Elisabeth Stammen; University of Braunschweig

08:30



Univ.-Prof. Dr.-Ing. Paul Ludwig Geiß RPTU University of Kaiserslautern-Landau, Workgroup Materials and Surface Technologies **Quality Assurance of Surfaces Prior to Adhesive Bonding**

08:55



Klaus Kresser; Plasmatreat Schweiz AG Openair® Plasma Technology for Wetting Sealing and Bonding in Battery Applications

09:20



Dr. Martin Brandtner-Hafner; Fracture Analytics Gap Filling Efficiency of Adhesive Sealants



REFRESHMENT BREAK

10:15

09:45



Tobias Illi; Sika Technology AG SikaPower-800 - Fast Curing and Injectable Epoxy Adhesive

10:40



Dr. Davide Malinverno; ELANTAS Europe **New Developments of Epoxy Adhesives**

11:05



Sven Wiemer; Schill+Seilacher "Struktol" GmbH **Biobased Toughness**

11:30



Prof. Martín-Martínez; University of Alicante

Physical Mixing of Waterborne Polyurethane and Nanosilica Dispersion. Is it a Feasible Strategy for Improving the Properties of Waterborne Polyurethane Adhesives?

12:00



13:30 LUNCH

13:30 WELCOME BY CHAIR: Univ.-Prof. Dr.-Ing. Paul Ludwig Geiß; RPTU University of Kaiserslautern-Landau

13:30



Dr. Matthias Koebel; Siloxene AG

Controlling Adhesion at the Molecular Level - New Multifunctional Dendrimer Silane Additives and **Resins for Functional Adhesives**

13:55



Dr. Vincent Lutz; nolax AG

Non-Isocyanate Polyurethanes (NIPUs): A Promising Pathway Towards Sustainable and **Environmentally Friendly Adhesives**

14:20



Luigi Mora; Vinavil SpA

Sustainable Development in Adhesives: Design of New Monomers and Formulations, Management of Wastes

14:45



Dr. Hartmut Henneken; Jowat SE

Recycling Adhesives - A Technological Oxymoron?

15:15

FAREWELL